

*Summer Undergraduate  
Biomedical Research Attachment  
School of Biomedical Sciences, CUHK*

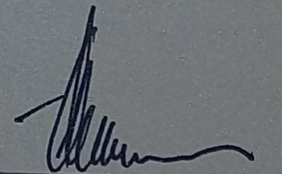
*This certificate is awarded to*

**CHAN VALERIE TANYA**

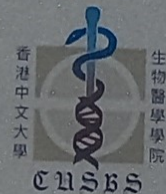
*for winning*

**JUDGES COMMENDATION AWARD**  
*in*  
**POSTER PRESENTATION**

*Summer 2023*



Prof CHAN Man Lok Andrew  
Director, School of Biomedical Sciences  
The Chinese University of Hong Kong





**2024**   
**Competition**

**OFFICIAL CERTIFICATE**

The iGEM Foundation certifies that the team

**CUHK-HongKong-SBS**

participated in the 2024 iGEM Competition, Undergrad Section.

The team was awarded:

**Silver Medal**



A handwritten signature in black ink, appearing to read 'Nemanja Stijepovic'.

**Nemanja Stijepovic**  
President & CEO, iGEM Foundation



**2024 GRAND  
JAMBOREE**

23–26 October, 2024  
Paris Convention Center, Paris



This certificate is valid electronically and  
can be verified here: [teams.igem.org/5402](https://teams.igem.org/5402)



**2024**   
**Competition**

## OFFICIAL CERTIFICATE

The iGEM Foundation certifies that

**Valerie Chan**

participated in the 2024 iGEM Competition, Undergrad Section,  
as a student leader of team

**CUHK-HongKong-SBS**

The team was awarded:

**Silver Medal**



A handwritten signature in black ink, appearing to read 'Nemanja Stijepovic'.

**Nemanja Stijepovic**  
President & CEO, iGEM Foundation

**iGEM** **2024 GRAND  
JAMBOREE**

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## 創新科技獎學金 *Innovation and Technology Scholarship*

7 May 2024

**Ms CHAN Valerie Tanya**  
c/o Office of Admissions and Financial Aid  
The Chinese University of Hong Kong

Dear Ms CHAN Valerie Tanya,

### **Innovation and Technology Scholarship 2024** **Scholarship Notification Letter**

We are pleased to advise you that the Awardee Selection Committee of the Innovation and Technology Scholarship has agreed, in principle, to award you the Innovation and Technology Scholarship 2024 (“the Scholarship”).

The total scholarship amount of not more than HK\$150,000 should cover both the allowance and insurance for the optional Local Internship Programme, expenses for the Ideations and Achievements Showcase and the expenses for the Overseas/ Mainland Attachment Programme, including tuition fees, insurance, airfare of an economy class return ticket, visa application fees, reasonable accommodation costs, books and a portion of living expenses during the sponsored attachment period of not more than fourteen months between 1 June 2024 and 31 July 2025, based on the projection period you have provided through application.

You will be allowed to go for more than one overseas/ Mainland attachment within the Scholarship. At least one of your trips must be longer than three weeks and at least one trip should be arranged to Mainland China. Prior to at least 3 months of each of your trips, you should submit the following documents to the Scholarship Office or equivalent of your university before you depart for the Overseas/ Mainland Attachment Programme:

- a proforma summary of the budget, checked and endorsed by your university; and
- an official admission by the target overseas/ Mainland institute.

As we will compare budgets submitted by other scholars who will study in the same country/ university, the final value of the scholarship may differ from the sum you proposed. The sum of the estimated cost of all your trips for the Overseas/ Mainland Attachment Programme approved by the Scholarship Secretariat, the final internship allowance calculated according to your actual attendance and the approved budgets for Ideations and Achievements Showcase will be the final scholarship amount, given that the maximum amount is HK\$150,000. May there be any extra spending that was not included in the proforma budget summary, or the actual cost of any item under the Overseas/ Mainland Attachment Programme differs from the budget, the awardee will not be able to claim for additional reimbursement despite the

秘書處 Secretariat

(cont'd)

approved scholarship amount is lower than HK\$150,000.

Upon the completion of your overseas/ Mainland attachment(s), you are required to submit a copy of your official transcript (if applicable) or a letter from the teaching staff of the overseas/ Mainland university to prove the completion of the planned attachment programme as soon as possible through your university. Should you fail to fulfil the study plan, internship plan or ideations plan, the surplus amount will have to be reimbursed to the Secretariat. More details will be provided in the Guidelines for Developing the Proforma Budget Summary.

You are also required to submit two written reports with photos, including a full version of about 3,000 words and a trimmed version of about 1,000 words, to the Scholarship Secretariat after completion of the whole Scholarship summing up your experience in soft copy via Scholarships Office or equivalent of your university not later than 31 July 2025.

Under the Mentorship Programme of the Scholarship, an outstanding personality in his/her profession will be assigned to be your mentor. The mentor-mentee matching result will be announced later, and you are encouraged to actively interact with your mentor during the Scholarship period. Meanwhile, you are also required to participate in the Service Project Programme, i.e. organising/ participating in at least one community activities relating to innovation and technology such as educational activities for local students to raise their interest in science and technology.

From now on, you will also automatically become a member of the Innovation and Technology Scholarship Alumni Association and Hub for the Future programme organised by HKFYG and HSBC, which is a networking platform for HSBC Scholars.

Should you have any inquiry regarding the above offer or other Scholarship-related matters, please feel free to contact the Scholarship Secretariat via email at [it\\_scholarship@hkfyg.org.hk](mailto:it_scholarship@hkfyg.org.hk).

All the best and wishing you every success!

Yours sincerely,



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**Mavum Cheung**

Supervisor (Information Technology & Creativity)

The Hong Kong Federation of Youth Groups